

D15XB80

PRV: 800 Volts lo: 15 Amperes

FEATURES:

- * High current capability
- * High surge current capability
- * High reliability
- * Low reverse current
- * Low forward voltage drop
- * Ideal for printed circuit board
- * Very good heat dissipation
- * Pb / RoHS Free

MECHANICAL DATA:

* Case : Reliable low cost construction utilizing molded plastic technique

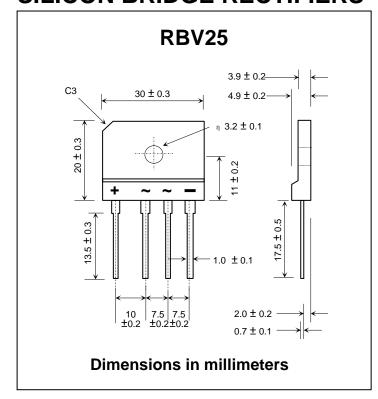
* Epoxy: UL94V-0 rate flame retardant

* Terminals : Plated lead solderable per MIL-STD-202, Method 208 guaranteed

* Polarity : Polarity symbols marked on case

* Mounting position : Any* Weight : 7.7 grams

SILICON BRIDGE RECTIFIERS



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25 °C ambient temperature unless otherwise specified.

RATING	SYMBOL	VALUE	UNIT
Maximum Recurrent Peak Reverse Voltage	V_{RM}	800	V
Maximum Average Forward Current With heatsink, Tc = 100 °C	I _O	15	А
(50Hz Sine wave, R-load) Without heatsink, Ta = 25 °C		3.2	
Maximum Peak Forward Surge Current, Tj = 25 °C	I _{FSM}	200	А
(50Hz sine wave, Non-repetitive 1 cycle peak value)			
Current Squared Time at 1ms ≤ t < 10 ms, Tc = 25 °C	l ² t	110	A ² S
Maximum Forward Voltage per Diode at IF = 7.5 A	V _F	1.1	V
(Pulse measurement, Rating of per diode)		1.1	
Maximum DC Reverse Current, VR=VRM	I _R	10	μА
(Pulse measurement, Rating of per diode)		10	
Maximum Thermal Resistance, Junction to case, With heatsink	$R_{\Theta JC}$	1.5	°C/W
Maximum Thermal Resistance, Junction to Ambient, Without heatsink	$R_{\Theta JA}$	22	°C/W
Maximum Thermal Resistance, Junction to Lead, Without heatsink	$R_{\Theta JL}$	5	°C/W
Operating Junction Temperature	TJ	150	°C
Storage Temperature Range	T _{STG}	- 40 to + 150	°C

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RATING AND CHARACTERISTIC CURVES (D15XB80)

FIG.1 - DERATING CURVE

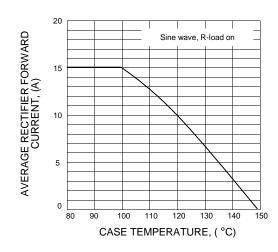


FIG.2 - MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

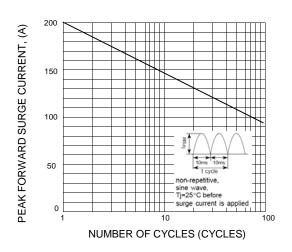


FIG.3 - TYPICAL FORWARD CHARACTERISTICS PER DIODE

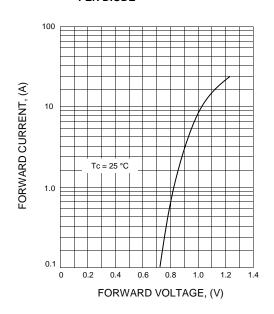
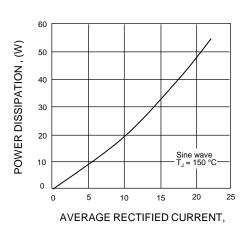


FIG.4 - POWER DISSIPATION



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